

Notice of References Cited	Application/Control No. 09/955,722	Applicant(s)/Patent Under Reexamination PETERSON ET AL.	
	Examiner Eugene Lee	Art Unit 2815	Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	A	US-4,691,225	09-1987	Murakami et al.	257/693
	B	US-5,291,062	03-1994	Higgins, III, Leo M.	257/698
	C	US-			
	D	US-			
	E	US-			
	F	US-			
	G	US-			
	H	US-			
	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					
	O					
	P					
	Q					
	R					
	S					
	T					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	C-Shield Parylene allows major weight saving for EM shielding of microelectronics, Jan Noordegraaf et al. IEEE 1997.
	V	Internal Conformal Coating for Microcircuits, Whittington et al. IEEE 1978.
	W	Hermetic Plastic packages with Applications to Ruggedized Boards, Val et al. IEEE 1991.
	X	Alkyltrichlorosilane-Based Self Assembled Monolayer Films for Stiction Reduction in Silicon Micromachines, Srinivasan et al. IEEE 1998.

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.